# mail

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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## Low-dropout regulators, high PSRR, 150 mA

Rev. 2 — 25 June 2012

**Product data sheet** 

## 1. Product profile

### 1.1 General description

The LD6805 series is a small-size Low DropOut regulator (LDO) family with ultra high Power Supply Rejection Ratio (PSRR) of 75 dB. The voltage drop is 250 mV at 150 mA current rating.

Operating voltages can range from 2.3 V to 5.5 V. The devices are available with fixed output voltages between 1.2 V to 3.6 V.

The LD6805K/xxH devices show a high-ohmic state at the output pin when set to disabled mode. The LD6805K/xxP devices contain a pull-down switching transistor to provide a low-ohmic output state (auto discharge function) in disabled mode.

The LD6805 series devices are available in a 1  $\times$  1 mm DFN plastic package making them ideal for use in portable applications requiring component miniaturization. All devices are manufactured in monolithic silicon technology.

### 1.2 Features and benefits

- 150 mA output current rating
- 75 dB PSRR at 1 kHz
- Input voltage range 2.3 V to 5.5 V
- Fixed output voltage between 1.2 V to 3.6 V
- Dropout voltage 250 mV at 150 mA output rating
- Low quiescent current in shutdown mode (typical 0.1 μA)
- 40 μV RMS output noise voltage (typical value) at 10 Hz to 100 kHz
- Turn-on time 150 μs
- LD6805K/xxH: high-ohmic (3-state) output state when disabled
- LD6805K/xxP: low-ohmic output state when disabled (auto discharge function)
- Integrated ESD protection up to 6 kV Human Body Model (HBM)
- DFN1010C-4 (SOT1194-1) plastic package with a size of 1 × 1 × 0.55 mm
- Pb-free, RoHS compliant and free of halogen and antimony (dark green compliant)

### **1.3 Applications**

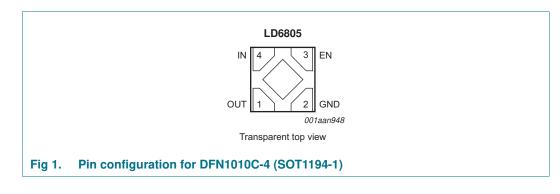
Analog and digital interfaces requiring lower than standard supply voltages in mobile appliances such as smart phones, mobile phone handsets and cordless telephones. Other typical applications are digital still cameras, mobile internet devices, personal navigation devices and portable media players.



Low-dropout regulators, high PSRR, 150 mA

## 2. Pinning information

### 2.1 Pinning



### 2.2 Pin description

#### Table 1. Pin description for DFN1010C-4 (SOT1194-1)

| Symbol | Pin | Description                       |
|--------|-----|-----------------------------------|
| OUT    | 1   | regulator output voltage          |
| GND    | 2   | supply ground                     |
| EN     | 3   | device enable input; active HIGH  |
| IN     | 4   | regulator input voltage           |
| i.c.   | TAB | internal connected <sup>[1]</sup> |

 The TAB is GND level (it is placed on the reverse side of the IC). It is recommended to connect the TAB to GND. Leaving it unconnected is also allowed but it may result in lower thermal performance.

## 3. Ordering information

| Table 2. Ordering information |            |                                                                                                                      |           |  |  |  |
|-------------------------------|------------|----------------------------------------------------------------------------------------------------------------------|-----------|--|--|--|
| Type number                   | Package    |                                                                                                                      |           |  |  |  |
|                               | Name       | Description                                                                                                          | Version   |  |  |  |
| LD6805 series                 | DFN1010C-4 | plastic thermal enhanced ultra thin small outline package; no leads; 4 terminals; body 1 $\times$ 1 $\times$ 0.55 mm | SOT1194-1 |  |  |  |

#### Low-dropout regulators, high PSRR, 150 mA

### 3.1 Ordering options

Further information on output voltage is available on request; see <u>Section 20 "Contact</u> information".

Table 3. Type number extension of high-ohmic output

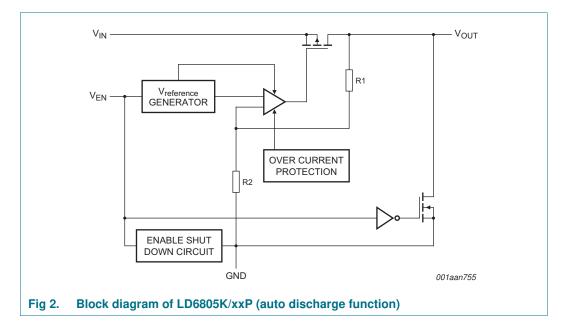
| Type number  | Nominal output<br>voltage | Type number | Nominal output<br>voltage |
|--------------|---------------------------|-------------|---------------------------|
| LD6805K/12H  | 1.2 V                     | LD6805K/22H | 2.2 V                     |
| LD6805K/13H  | 1.3 V                     | LD6805K/23H | 2.3 V                     |
| LD6805K/14H  | 1.4 V                     | LD6805K/25H | 2.5 V                     |
| LD6805K/15H  | 1.5 V                     | LD6805K/28H | 2.8 V                     |
| LD6805K/16H  | 1.6 V                     | LD6805K/29H | 2.9 V                     |
| LD6805K/18H  | 1.8 V                     | LD6805K/30H | 3.0 V                     |
| LD6805K/185H | 1.85 V                    | LD6805K/31H | 3.1 V                     |
| LD6805K/20H  | 2.0 V                     | LD6805K/33H | 3.3 V                     |
| LD6805K/21H  | 2.1 V                     | LD6805K/36H | 3.6 V                     |

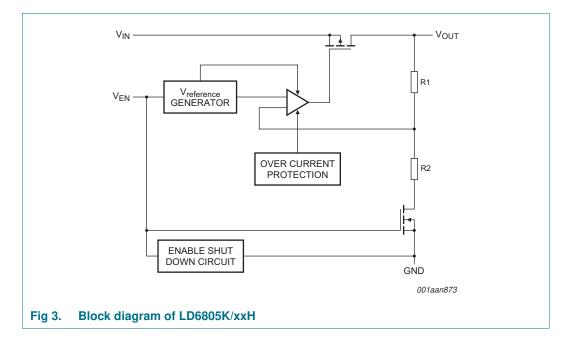
#### Table 4. Type number extension of pull-down output

| Type number | Nominal output<br>voltage | Type number | Nominal output<br>voltage |
|-------------|---------------------------|-------------|---------------------------|
| LD6805K/12P | 1.2 V                     | LD6805K/23P | 2.3 V                     |
| LD6805K/13P | 1.3 V                     | LD6805K/25P | 2.5 V                     |
| LD6805K/14P | 1.4 V                     | LD6805K/28P | 2.8 V                     |
| LD6805K/15P | 1.5 V                     | LD6805K/29P | 2.9 V                     |
| LD6805K/16P | 1.6 V                     | LD6805K/30P | 3.0 V                     |
| LD6805K/18P | 1.8 V                     | LD6805K/31P | 3.1 V                     |
| LD6805K/20P | 2.0 V                     | LD6805K/33P | 3.3 V                     |
| LD6805K/21P | 2.1 V                     | LD6805K/36P | 3.6 V                     |
| LD6805K/22P | 2.2 V                     | -           | -                         |

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## 4. Block diagram





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## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                       | Conditions               | Min          | Max  | Unit |
|------------------|---------------------------------|--------------------------|--------------|------|------|
| V <sub>IN</sub>  | voltage on pin IN               | 4 ms transient           | -0.5         | +6.0 | V    |
| P <sub>tot</sub> | total power dissipation         |                          | <u>[1]</u> - | 400  | mW   |
| T <sub>stg</sub> | storage temperature             |                          | -55          | +150 | °C   |
| Tj               | junction temperature            |                          | -40          | +125 | °C   |
| T <sub>amb</sub> | ambient temperature             |                          | -40          | +85  | °C   |
| V <sub>ESD</sub> | electrostatic discharge voltage | human body model level 6 | [2] _        | ±6   | kV   |
|                  |                                 | machine model class 3    | <u>[3]</u> _ | ±400 | V    |

[1] The (absolute) maximum power dissipation depends on the junction temperature  $T_j$ . Higher power dissipation is allowed with lower ambient temperatures. The conditions to determine the specified values are  $T_{amb} = 25$  °C and the use of a two layer PCB.

[2] According to IEC 61340-3-1.

[3] According to JESD22-A115C.

## 6. Recommended operating conditions

#### Table 6.Operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                 | Conditions | Min     | Тур | Мах             | Unit |
|---------------------|---------------------------|------------|---------|-----|-----------------|------|
| T <sub>amb</sub>    | ambient temperature       |            | -40     | -   | +85             | °C   |
| Tj                  | junction temperature      |            | -       | -   | +125            | °C   |
| Pin IN              |                           |            |         |     |                 |      |
| V <sub>IN</sub>     | voltage on pin IN         |            | 2.3     | -   | 5.5             | V    |
| Pin EN              |                           |            |         |     |                 |      |
| $V_{\text{EN}}$     | voltage on pin EN         |            | 0       | -   | V <sub>IN</sub> | V    |
| Pin OUT             |                           |            |         |     |                 |      |
| C <sub>L(ext)</sub> | external load capacitance |            | [1] 0.7 | 1.0 | -               | μF   |

[1] See <u>Section 10.1 "Output capacitor values"</u>.

## 7. Thermal characteristics

#### Table 7.Thermal characteristics

| Symbol               | Parameter                                   | Conditions | Тур               | Unit |
|----------------------|---------------------------------------------|------------|-------------------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient |            | <u>[1][2]</u> 250 | K/W  |

[1] The overall R<sub>th(j-a)</sub> can vary depending on the board layout. To minimize the effective R<sub>th(j-a)</sub>, all pins must have a solid connection to larger Cu layer areas for example to the power and ground layer. In multi-layer PCB applications, the second layer is used to create a large heat spreader area directly below the LDO. If this layer is either ground or power, it is connected with several vias to the top layer connecting to the device ground or supply. Avoid the use of solder-stop varnish under the chip.

[2] Use the measurement data given for a rough estimation of the R<sub>th(j-a)</sub> in your application. The actual R<sub>th(j-a)</sub> value can vary in applications using different layer stacks and layouts.

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## 8. Characteristics

#### Table 8. Electrical characteristics

At recommended input voltages and  $T_{amb} = -40$  °C to +85 °C; voltages are referenced to GND (ground = 0 V); unless otherwise specified.

| Symbol                                | Parameter                                                | Conditions                                                                                                                                                                            | Min             | Тур    | Мах  | Unit |
|---------------------------------------|----------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|--------|------|------|
| Output voltag                         | e                                                        |                                                                                                                                                                                       |                 |        |      |      |
| V <sub>do</sub>                       | dropout voltage                                          | $I_{OUT}$ = 150 mA; $V_{IN} < V_{O(nom)}$                                                                                                                                             | <u>[1]</u> -    | 250    | -    | mV   |
| $\Delta V_O$                          | output voltage variation                                 | V <sub>OUT</sub> < 1.8 V; I <sub>OUT</sub> = 1 mA                                                                                                                                     |                 |        |      |      |
|                                       |                                                          | T <sub>amb</sub> = +25 °C                                                                                                                                                             | -3              | ±0.5   | +3   | %    |
|                                       |                                                          | $-30 ^\circ\text{C} \leq T_{amb} \leq +85 ^\circ\text{C}$                                                                                                                             | -4              | -      | +4   | %    |
|                                       |                                                          | $V_{OUT} \geq 1.8 \ V; \ I_{OUT} = 1 \ mA$                                                                                                                                            |                 |        |      |      |
|                                       |                                                          | T <sub>amb</sub> = +25 °C                                                                                                                                                             | -2              | ±0.5   | +2   | %    |
|                                       |                                                          | $-30 ^\circ\text{C} \leq T_{amb} \leq +85 ^\circ\text{C}$                                                                                                                             | -3              | -      | +3   | %    |
| Line regulation                       | error                                                    |                                                                                                                                                                                       |                 |        |      |      |
| $\Delta V_{O}/(V_{O} x \Delta V_{I})$ | relative output voltage<br>variation with input voltage  | $V_{IN} = (V_{O(nom)} + 0.5 V)$ to 5.5 V                                                                                                                                              | <u>[1]</u> –0.1 | -      | +0.1 | %/V  |
| Load regulatio                        | n error                                                  |                                                                                                                                                                                       |                 |        |      |      |
| $\Delta V_{O}/(V_{O}x\Delta I_{O})$   | relative output voltage<br>variation with output current | 1 mA $\leq$ I <sub>OUT</sub> $\leq$ 150 mA                                                                                                                                            | -               | 0.0025 | 0.01 | %/mA |
| Output currer                         | nt                                                       |                                                                                                                                                                                       |                 |        |      |      |
| I <sub>OUT</sub>                      | current on pin OUT                                       |                                                                                                                                                                                       | -               | -      | 150  | mA   |
| I <sub>OM</sub>                       | peak output current                                      | $V_{IN} = (V_{O(nom)} + 0.5 \text{ V}) \text{ to } 5.5 \text{ V}$                                                                                                                     | <u>[1]</u>      |        |      |      |
|                                       |                                                          | $V_{O(nom)} > 1.8 V;$<br>$V_{OUT} = 0.95 \times V_{O(nom)}$                                                                                                                           | 200             | -      | -    | mA   |
|                                       |                                                          | V <sub>O(nom)</sub> < 1.8 V;                                                                                                                                                          | 200             | -      | -    | mA   |
|                                       |                                                          | $V_{OUT} = 0.9 \times V_{O(nom)}$                                                                                                                                                     |                 |        |      |      |
| I <sub>sc</sub>                       | short-circuit current                                    | pin OUT                                                                                                                                                                               | -               | 300    | -    | mA   |
| Regulator qui                         | escent current                                           |                                                                                                                                                                                       |                 |        |      |      |
| lq                                    | quiescent current                                        | V <sub>EN</sub> = 1.1 V; I <sub>OUT</sub> = 0 mA                                                                                                                                      | -               | 35     | -    | μA   |
|                                       |                                                          | $V_{EN}$ = 1.1 V; 1 mA $\leq I_{OUT} \leq$ 150 mA                                                                                                                                     | -               | 150    | -    | μA   |
|                                       |                                                          | $V_{EN} \le 0.4 V$                                                                                                                                                                    | -               | 0.1    | 1    | μA   |
| <b>Ripple rejecti</b>                 | on and output noise                                      |                                                                                                                                                                                       |                 |        |      |      |
| PSRR                                  | power supply rejection ratio                             | $\label{eq:VIN} \begin{array}{l} V_{IN} = V_{O(nom)} + 1.0 \ V; \ I_{OUT} = 50 \ mA; \\ f_{ripple} = 1 \ kHz \end{array}$                                                             | <u>[1]</u> -    | -75    | -    | dB   |
| V <sub>n(o)(RMS)</sub>                | RMS output noise voltage                                 | $f_{ripple}$ = 10 Hz to 100 kHz;<br>$C_{L(ext)}$ = 1 $\mu$ F                                                                                                                          | -               | 40     | -    | μV   |
| Enable input                          | and timing                                               |                                                                                                                                                                                       |                 |        |      |      |
| V <sub>IL</sub>                       | LOW-level input voltage                                  | pin EN                                                                                                                                                                                | 0               | -      | 0.4  | V    |
| V <sub>IH</sub>                       | HIGH-level input voltage                                 | pin EN                                                                                                                                                                                | 1.1             | -      | 5.5  | V    |
| t <sub>startup(reg)</sub>             | regulator start-up time                                  | $\label{eq:VIN} \begin{array}{l} V_{IN} = 5.5 \ \text{V}; \ \text{V}_{OUT} = 0.95 \times \text{V}_{O(nom)}; \\ I_{OUT} = 150 \ \text{mA}; \ C_{L(ext)} = 1 \ \mu\text{F} \end{array}$ | <u>[1]</u> _    | 150    | -    | μS   |

#### Low-dropout regulators, high PSRR, 150 mA

#### Table 8. Electrical characteristics ...continued

At recommended input voltages and  $T_{amb} = -40$  °C to +85 °C; voltages are referenced to GND (ground = 0 V); unless otherwise specified.

| Symbol               | Parameter                            | Conditions                                                                                                                    | Min | Тур | Max | Unit |  |
|----------------------|--------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|--|
| LD6805K/xx           | LD6805K/xxP; auto discharge function |                                                                                                                               |     |     |     |      |  |
| t <sub>sd(reg)</sub> | regulator shutdown time              | $\label{eq:VIN} \begin{array}{l} V_{IN} = 5.5 \ V; \ V_{OUT} = 0.05 \times V_{O(nom)}; \\ C_{L(ext)} = 1 \ \mu F \end{array}$ | -   | 300 | -   | μS   |  |
| R <sub>pd</sub>      | pull-down resistance                 |                                                                                                                               | -   | 100 | -   | Ω    |  |

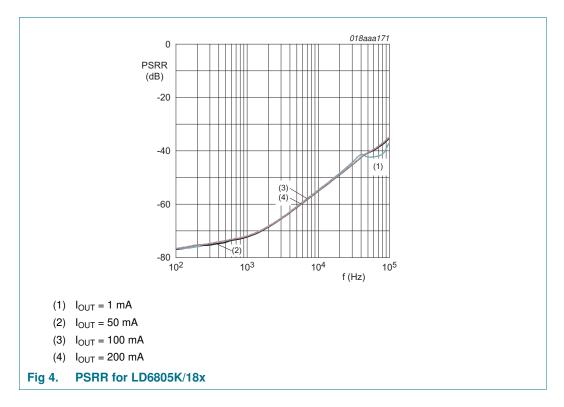
 $\label{eq:VO(nom)} \mbox{I} 1\mbox{I} \ V_{O(nom)} = \mbox{nominal output voltage (device specific)}.$ 

### 9. Dynamic behavior

## 9.1 Power Supply Rejection Ratio (PSRR)

PSRR stands for the capability of the regulator to suppress unwanted signals on the input voltage like noise or ripples.

 $PSRR[dB] = 20log \frac{V_{out(ripple)}}{V_{in(ripple)}}$  for all frequencies



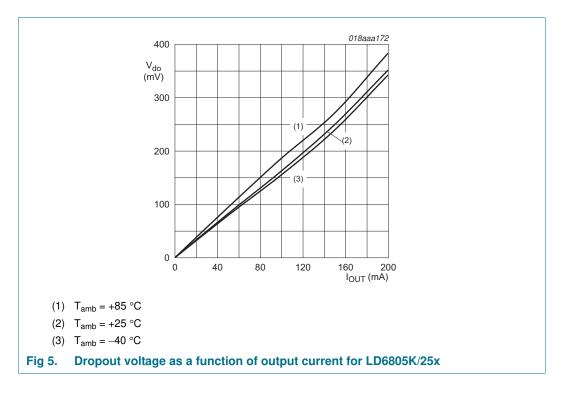
LD6805 SER

#### Low-dropout regulators, high PSRR, 150 mA

#### 9.2 Dropout

The dropout voltage is defined as the smallest input to output voltage difference at a specified load current when the regulator operates within its linear region. This means that the input voltage is below the nominal output voltage value and the pass transistor works as a plain resistor.

A small dropout voltage guarantees lower power consumption and efficiency maximization.

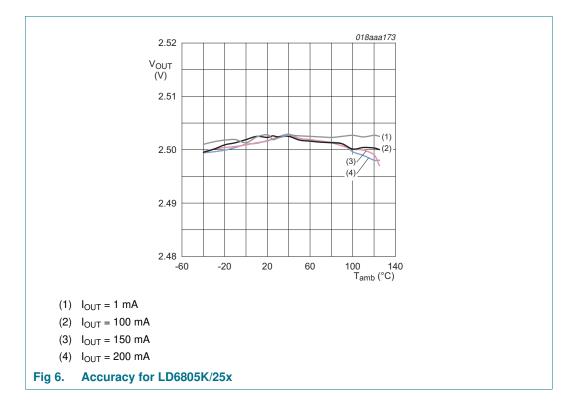


LD6805 SER

Low-dropout regulators, high PSRR, 150 mA

#### 9.3 Accuracy

The LD6805 series guarantees high accuracy of the nominal output voltage.



## **10. Application information**

### 10.1 Output capacitor values

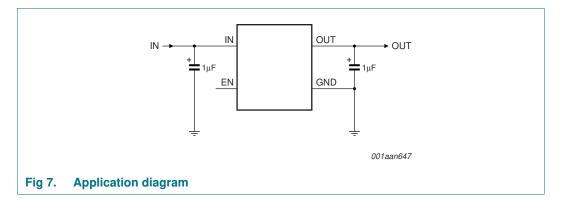
The LD6805 series requires external capacitors at the output to guarantee a stable regulator behavior. Also an input capacitor is recommended to keep the input voltage stable. It is not allowed to under-run the specified minimum Equivalent Series Resistance (ESR).

The absolute value of the total capacitance attached to the output pin OUT influences the shutdown time  $(t_{sd(reg)})$  of the LD6805 series.

| Table 9.            | External load capacitor      |            |              |     |     |      |
|---------------------|------------------------------|------------|--------------|-----|-----|------|
| Symbol              | Parameter                    | Conditions | Min          | Тур | Max | Unit |
| C <sub>L(ext)</sub> | external load capacitance    |            | <u>[1]</u> _ | 1.0 | -   | μF   |
| ESR                 | equivalent series resistance |            | 5            | -   | 500 | mΩ   |

[1] The minimum value of capacitance for stability and correct operation is 0.7 µF. The specified capacitor tolerance is ±30 % or better over the temperature and operating conditions range. The recommended capacitor type is X7R to meet the full device temperature specification of -40 °C to +125 °C.

Low-dropout regulators, high PSRR, 150 mA



## **11. Test information**

## 11.1 Quality information

This product has been qualified in accordance with *NX2-00001 NXP Semiconductors Quality and Reliability Specification* and is suitable for use in consumer applications.

### 12. Marking

| Table 10. Marl | king of high-ohmi | c output        |             |         |                 |
|----------------|-------------------|-----------------|-------------|---------|-----------------|
| Type number    | Voltage           | Version<br>code | Type number | Voltage | Version<br>code |
| LD6805K/12H    | 1.2 V             | AH              | LD6805K/22H | 2.2 V   | KH              |
| LD6805K/13H    | 1.3 V             | BH              | LD6805K/23H | 2.3 V   | LH              |
| LD6805K/14H    | 1.4 V             | СН              | LD6805K/25H | 2.5 V   | NH              |
| LD6805K/15H    | 1.5 V             | DH              | LD6805K/28H | 2.8 V   | QH              |
| LD6805K/16H    | 1.6 V             | EH              | LD6805K/29H | 2.9 V   | RH              |
| LD6805K/18H    | 1.8 V             | GH              | LD6805K/30H | 3.0 V   | SH              |
| LD6805K/185H   | 1.85 V            | 5H              | LD6805K/31H | 3.1 V   | TH              |
| LD6805K/20H    | 2.0 V             | IH              | LD6805K/33H | 3.3 V   | VH              |
| LD6805K/21H    | 2.1 V             | JH              | LD6805K/36H | 3.6 V   | YH              |

#### Table 11. Marking of pull-down output

| Type number | Voltage | Version<br>code | Type number | Voltage | Version<br>code |
|-------------|---------|-----------------|-------------|---------|-----------------|
| LD6805K/12P | 1.2 V   | AP              | LD6805K/23P | 2.3 V   | LP              |
| LD6805K/13P | 1.3 V   | BP              | LD6805K/25P | 2.5 V   | NP              |
| LD6805K/14P | 1.4 V   | CP              | LD6805K/28P | 2.8 V   | QP              |
| LD6805K/15P | 1.5 V   | DP              | LD6805K/29P | 2.9 V   | RP              |
| LD6805K/16P | 1.6 V   | EP              | LD6805K/30P | 3.0 V   | SP              |
| LD6805K/18P | 1.8 V   | GP              | LD6805K/31P | 3.1 V   | TP              |
| LD6805K/20P | 2.0 V   | IP              | LD6805K/33P | 3.3 V   | VP              |
| LD6805K/21P | 2.1 V   | JP              | LD6805K/36P | 3.6 V   | YP              |
| LD6805K/22P | 2.2 V   | KP              | -           | -       | -               |

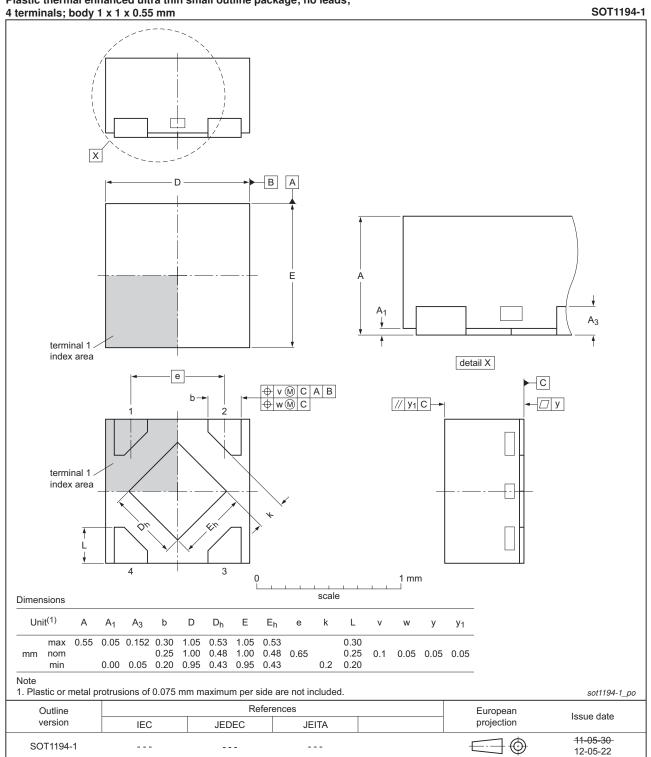
LD6805\_SER Product data sheet

#### **NXP Semiconductors**

## LD6805 series

Low-dropout regulators, high PSRR, 150 mA

## 13. Package outline



Plastic thermal enhanced ultra thin small outline package; no leads;

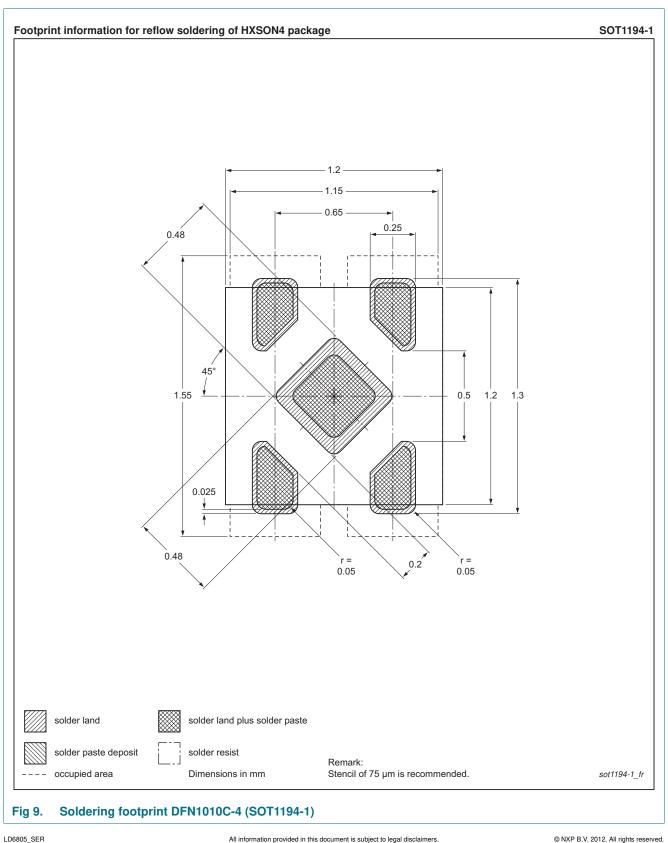
#### Fig 8.Package outline DFN1010C-4 (SOT1194-1)

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LD6805\_SER

Low-dropout regulators, high PSRR, 150 mA

## 14. Soldering



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#### Low-dropout regulators, high PSRR, 150 mA

### 15. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

#### 15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

### 15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

#### 15.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

#### Low-dropout regulators, high PSRR, 150 mA

#### 15.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 10</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 12 and 13

#### Table 12. SnPb eutectic process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) |       |
|------------------------|---------------------------------|-------|
|                        | Volume (mm <sup>3</sup> )       |       |
|                        | < 350                           | ≥ 350 |
| < 2.5                  | 235                             | 220   |
| ≥ 2.5                  | 220                             | 220   |

#### Table 13. Lead-free process (from J-STD-020C)

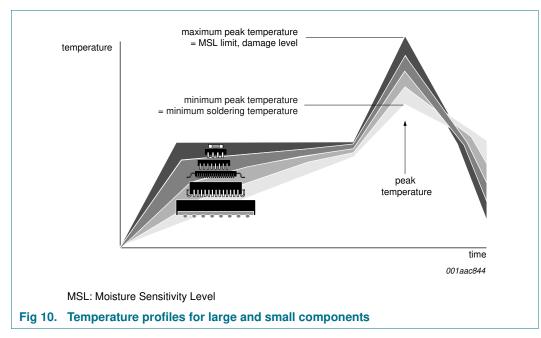
| Package thickness (mm) | Package reflow temperature (°C) |             |        |
|------------------------|---------------------------------|-------------|--------|
|                        | Volume (mm <sup>3</sup> )       |             |        |
|                        | < 350                           | 350 to 2000 | > 2000 |
| < 1.6                  | 260                             | 260         | 260    |
| 1.6 to 2.5             | 260                             | 250         | 245    |
| > 2.5                  | 250                             | 245         | 245    |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 10.

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For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

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### 16. Abbreviations

| Table 14. | Abbreviations                       |
|-----------|-------------------------------------|
| Acronym   | Description                         |
| ESD       | ElectroStatic Discharge             |
| HBM       | Human Body Model                    |
| LDO       | Low DropOut                         |
| MM        | Machine Model                       |
| OSP       | Organic Solderability Preservation  |
| PCB       | Printed-Circuit Board               |
| PSRR      | Power Supply Rejection Ratio        |
| RMS       | Root Mean Square                    |
| RoHS      | Restriction of Hazardous Substances |

### **17. References**

- [1] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [2] IEC 61340-3-1 Methods for simulation of electrostatic effects Human body model (HBM) electrostatic discharge test waveforms
- [3] JESD22-A115C Electrostatic discharge (ESD) Sensitivity Testing Machine Model (MM)
- [4] NX2-00001 NXP Semiconductors Quality and Reliability Specification
- [5] AN10365 Surface mount reflow soldering description

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## **18. Revision history**

| Table 15. Revision hi                    | story        |                      |               |                |
|------------------------------------------|--------------|----------------------|---------------|----------------|
| Document ID                              | Release date | Data sheet status    | Change notice | Supersedes     |
| LD6805_SER v.2                           | 20120625     | Product data sheet   | -             | LD6805_SER v.1 |
| Modifications:  • Block diagrams updated |              |                      |               |                |
| Minor text changes                       |              |                      |               |                |
| LD6805_SER v.1                           | 20110922     | Objective data sheet | -             | -              |

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## **19. Legal information**

#### **19.1 Data sheet status**

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition                                                                            |
|--------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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#### Low-dropout regulators, high PSRR, 150 mA

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